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Peclaration For U.S. Patent Application

/ 25	<u>&</u>				
As a below n	amed inve	entor, I hereby declare that:			
My residence I believe I a first and jo	e, post off m the ori oint invo d for whice	ice address and citizenship a ginal, first and sole invento entor (if plural names ar th a patent is sought on the in	or (if only one na e listed below)	me is listed below of the subject	natter which is
the specificat	tion of wh	ich			······································
(Check one	1	_ is attached hereto.			
of 1, 2, or 3.)	2	_ was filed on International PCT Applica	tion No.	as	
		and was amended on			_ •
	_	~. .	(if app	licable)	
	3	_ was filed on			as

I hereby state that I have reviewed and understand the content of the above-identified specification, including the claim(s), as amended by any amendment referred to above.

U.S. Application Serial No. and was amended on

I acknowledge the duty to disclose information which is material to the patentability of this application as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed:

List prior foreign				Priority Claimed		
applications.)	<u>10-157799</u>	Japan	05/06/1998	<u>x</u>	Yes	No
	(Number)	(Country)	(Day/Month/Year Filed)			
					Yes	No
	(Number)	(Country)	(Day/Month/Year Filed)			
					Yes	No
	(Number)	(Country)	(Day/Month/Year Filed)	_		-
	See atta	ached list for add	itional prior foreign applications			

I hereby claim the benefit under Title 35, United States Code, § 120, of any United States patent application listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56, which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

09/323,960	June 2, 1999	Pending
(Application Serial No.)	(Filing Date)	(Status)

And I hereby appoint as principal attorney and agent Ronald J. Kubovcik, Reg. No. 25,401; and Keiko T. Kubovcik, Reg. No. 40,428.

Please direct all communications to the following address:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first or sole inventor: Kazuo SAITO Inventor's Signature: hage Saite Residence: Chiba, Japan	_Data:	August	24,	2001
Citizenship: Japan				
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Full name of second inventor: Atsushi HAGIWARA Inventor's Signature: Chiba, Japan	_Data: .	August	24,	2001
Citizenship: Japan				
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Full name of third inventor: Seiji YAMAMOTO Inventor's Signature: Residence: Chiba, Japan	_Data:	August	24,	2001
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